



**SLOVENSKI STANDARD**  
**oSIST prEN IEC 62506:2023**  
**01-januar-2023**

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**Metode za pospešeno preskušanje proizvodov**

Methods for product accelerated testing

Verfahren für beschleunigte Produktprüfungen

Méthodes d'essais accélérés de produits

**Ta slovenski standard je istoveten z: prEN IEC 62506:2022**

<https://standards.iteh.ai/catalog/standards/sist/7994cb48-cdd5-4908-94bd-146f3c125108/osist-pr-en-iec-62506-2023>

**ICS:**

03.120.01	Kakovost na splošno	Quality in general
19.020	Preskuševalni pogoji in postopki na splošno	Test conditions and procedures in general
21.020	Značilnosti in načrtovanje strojev, aparatov, opreme	Characteristics and design of machines, apparatus, equipment

**oSIST prEN IEC 62506:2023**

**en**





# 56/1966/CDV

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SECRETARIAT: United Kingdom	SECRETARY: Ms Stephanie Lavy
OF INTEREST TO THE FOLLOWING COMMITTEES:	PROPOSED HORIZONTAL STANDARD: <input type="checkbox"/> Other TC/SCs are requested to indicate their interest, if any, in this CDV to the secretary.
FUNCTIONS CONCERNED: <input type="checkbox"/> EMC <input type="checkbox"/> ENVIRONMENT <input type="checkbox"/> QUALITY ASSURANCE <input checked="" type="checkbox"/> SAFETY	
<input checked="" type="checkbox"/> SUBMITTED FOR CENELEC PARALLEL VOTING	<input type="checkbox"/> NOT SUBMITTED FOR CENELEC PARALLEL VOTING
<p><b>Attention IEC-CENELEC parallel voting</b></p> <p>The attention of IEC National Committees, members of CENELEC, is drawn to the fact that this Committee Draft for Vote (CDV) is submitted for parallel voting.</p> <p>The CENELEC members are invited to vote through the CENELEC online voting system.</p>	

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TITLE:

**Methods for product accelerated testing**

PROPOSED STABILITY DATE: 2025

NOTE FROM TC/SC OFFICERS:

## 1 CONTENTS

2	FOREWORD .....	5
3	INTRODUCTION.....	7
4	1 Scope.....	8
5	2 Normative references.....	8
6	3 Terms, definitions, symbols and abbreviations .....	9
7	3.1 Terms and definitions .....	9
8	3.2 Symbols and abbreviated terms.....	11
9	4 General description of the accelerated test methods.....	12
10	4.1 Cumulative damage model .....	12
11	4.2 Classification, methods and types of test acceleration .....	14
12	4.2.1 General.....	14
13	4.2.2 Type A: qualitative accelerated tests .....	15
14	4.2.3 Type B: quantitative accelerated tests .....	15
15	4.2.4 Type C: quantitative time and event compressed tests.....	16
16	5 Accelerated test models .....	17
17	5.1 Type A, qualitative accelerated tests .....	17
18	5.1.1 Highly accelerated limit tests (HALT).....	17
19	5.1.2 Highly accelerated stress test (HAST).....	21
20	5.1.3 Highly accelerated stress screening/audit (HASS/HASA).....	21
21	5.1.4 Engineering aspects of HALT and HASS .....	22
22	5.2 Type B and C – Quantitative accelerated test methods.....	23
23	5.2.1 Purpose of quantitative accelerated testing .....	23
24	5.2.2 Physical basis for the quantitative accelerated Type B test	
25	methods.....	23
26	5.2.3 Type C tests, time ( $C_1$ ) and event ( $C_2$ ) compression.....	24
27	5.3 Failure mechanisms and test design .....	26
28	5.4 Determination of stress levels, profiles and combinations in use and test –	
29	stress modelling .....	27
30	5.4.1 General.....	27
31	5.4.2 Step-by-step procedure .....	27
32	5.5 Multiple stress acceleration methodology – Type B tests .....	27
33	5.6 Single and multiple stress acceleration for Type B tests.....	30
34	5.6.1 Single stress acceleration methodology.....	30
35	5.6.2 Stress models with stress varying as a function of time – Type	
36	B tests .....	37
37	5.6.3 Stress models that depend on repetition of stress applications	
38	– Fatigue models.....	39
39	5.6.4 Other acceleration models – Time and event compression .....	40
40	5.7 Acceleration of quantitative reliability tests.....	41
41	5.7.1 Reliability requirements, goals, and use profile .....	41

42	5.7.2	Reliability demonstration or life tests.....	43
43	5.7.3	Testing of components for a reliability measure .....	53
44	5.7.4	Reliability measures for components and systems/items .....	54
45	5.8	Accelerated reliability compliance or evaluation tests .....	54
46	5.9	Accelerated reliability growth testing.....	56
47	5.10	Guidelines for accelerated testing.....	56
48	5.10.1	Accelerated testing for multiple stresses and the known use profile.....	56
49			
50	5.10.2	Level of accelerated stresses.....	57
51	5.10.3	Accelerated reliability and verification tests .....	57
52	6	Accelerated testing strategy in product development.....	57
53	6.1	Accelerated testing sampling plan.....	57
54	6.2	General discussion about test stresses and durations.....	58
55	6.3	Testing components for multiple stresses.....	59
56	6.4	Accelerated testing of assemblies.....	59
57	6.5	Accelerated testing of systems .....	59
58	6.6	Analysis of test results .....	59
59	7	Limitations of accelerated testing methodology.....	60
60	Annex A (informative)	Highly accelerated limit test (HALT).....	61
61	Annex B (informative)	Accelerated reliability compliance and growth test design .....	66
62	Annex C (informative)	Comparison between HALT and conventional accelerated	
63	testing .....	<b>Error! Bookmark not defined.</b>	
64	Annex D (informative)	Estimating the activation energy, $E_a$ .....	74
65	Annex E (informative)	Calibrated accelerated life testing (CALT).....	76
66	Annex F (informative)	Example on how to estimate empirical factors .....	78
67	Annex G (informative)	Determination of acceleration factors by testing to failure .....	82
68	Bibliography.....		87
69			
70	Figure 1 – Probability density functions (PDF) for cumulative damage, degradation,		
71	and test types .....		13
72	Figure 2 – Relationship of PDFs of the item strength vs. load in use.....		18
73	Figure 3 – How uncertainty of load and strength affects the test policy.....		19
74	Figure 4 – PDFs of operating and destruct limits as a function of applied stress .....		20
75	Figure 5 – Line plot for Arrhenius reaction model .....		34
76	Figure 6 – Plot for determination of the activation energy .....		35
77	Figure 7 – Multiplier of the test stress duration for demonstration of required reliability		
78	for compliance or reliability growth testing.....	<b>Error! Bookmark not defined.</b>	
79	Figure 8 – Multiplier of the duration of the load application for the desired reliability ..	<b>Error!</b>	
80	<b>Bookmark not defined.</b>		
81	Figure B.1 – Reliability as a function of multiplier $k$ and for combinations of		
82	parameters $a$ and $b$ .....	<b>Error! Bookmark not defined.</b>	

83	Figure B.2 – Determination of the multiplier $k$ .....	<b>Error! Bookmark not defined.</b>
84	Figure B.3 – Determination of the growth rate .....	<b>Error! Bookmark not defined.</b>
85	Figure D.1 – Plotting failures to estimate the activation energy $E_a$ .....	75
86	Figure F.1 – Weibull graphical data analysis .....	80
87	Figure F.2 – Scale parameter as a function of the temperature range .....	<b>Error! Bookmark not defined.</b>
88		
89	Figure F.3 – Probability of failure as a function of number of cycles $\Delta T = 50$ °C .....	<b>Error!</b>
90		<b>Bookmark not defined.</b>
91	Figure G.1 – Weibull plot of the three data sets.....	83
92	Figure G.2 – Scale parameters' values fitted with a power line.....	<b>Error! Bookmark not defined.</b>
93		
94	Table 1 – Test types mapped to the development cycle.....	14
95	Table A.1 – Summary of HALT test results for a DC/DC converter.....	63
96	Table A.2 – Summary of HALT results from a medical system.....	64
97	Table A.3 – Summary of HALT results for a Hi-Fi equipment.....	65
98	Table B.1 – Environmental stress conditions of an automotive electronic device .....	68
99	Table B.2 – Item use parameters .....	<b>Error! Bookmark not defined.</b>
100	Table B.3 – Assumed item use profile .....	<b>Error! Bookmark not defined.</b>
101	Table B.4 – Worksheet for determination of use times to failures .....	<b>Error! Bookmark not defined.</b>
102		<b>defined.</b>
103	Table B.5 – Data for reliability growth plotting.....	<b>Error! Bookmark not defined.</b>
104	Table C.1 – Comparison between HALT and conventional accelerated testing.....	<b>Error!</b>
105		<b>Bookmark not defined.</b>
106	Table F.1 – Probability of failure of test samples A and B.....	79
107	Table F.2 – Data transformation for Weibull plotting .....	<b>Error! Bookmark not defined.</b>
108	Table G.1 – Voltage test failure data for Weibull distribution.....	82
109		
110		

## INTERNATIONAL ELECTROTECHNICAL COMMISSION

## METHODS FOR PRODUCT ACCELERATED TESTING

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International Standard IEC 62506 has been prepared by IEC technical committee 56: Dependability.

Edition 2 correct a number of errors in Edition 1, mainly in Clause 5.7.2.3 and Annex B. A number of calculation errors in the examples in Annex B and F have been corrected. Further the references have been updated and the symbols have been revised.

Further the references have been updated.

The text of this standard is based on the following documents:

FDIS	Report on voting
56/1503/FDIS	56/1513/RVD

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

157 The committee has decided that the contents of this publication will remain unchanged until the  
158 stability date indicated on the IEC web site under "http://webstore.iec.ch" in the data related to  
159 the specific publication. At this date, the publication will be

- 160 • reconfirmed,
  - 161 • withdrawn,
  - 162 • replaced by a revised edition, or
  - 163 • amended.
- 164

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167

## INTRODUCTION

168 Many reliability or failure investigation test methods have been developed and most of them are  
169 currently in use. These methods are used to either determine product reliability or to identify  
170 potential product failure modes, and have been considered effective as demonstrations of  
171 reliability:

- 172 – fixed duration,
- 173 – sequential probability ratio,
- 174 – reliability growth tests,
- 175 – tests to failure, etc.

176 Such tests, although very useful, are usually lengthy, especially when the product reliability that  
177 has to be demonstrated was high. The reduction in time-to-market periods as well as  
178 competitive product cost, increase the need for efficient and effective accelerated testing. Here,  
179 the tests are shortened through the application of increased stress levels or by increasing the  
180 speed of application of repetitive stresses, thus facilitating a quicker assessment and growth of  
181 product reliability through failure mode discovery and mitigation.

182 There are two distinctly different approaches to reliability activities:

- 183 – the first approach verifies, through analysis and testing, that there are no potential failure modes in  
184 the product that are likely to be activated during the expected life time of the product under the  
185 expected operating conditions and usage profile;
- 186 – the second approach estimates how many failures can be expected after a given time under the  
187 expected operating conditions and usage profile.

188 Accelerated testing is a method appropriate for both cases, but used quite differently. The first  
189 approach is associated with qualitative accelerated testing, where the goal is identification of  
190 potential faults that eventually might result in product field failures. The second approach is  
191 associated with quantitative accelerated testing where the product reliability may be estimated  
192 based on the results of accelerated simulation testing that can be related back to the use of the  
193 environment and usage profile.

194 Accelerated testing can be applied to multiple levels of items containing hardware or software.  
195 Different types of reliability testing, such as fixed duration, sequential test-to-failure, success  
196 test, reliability demonstration, or reliability growth/improvement tests can be candidates for  
197 accelerated methods. This standard provides guidance on selected, commonly used  
198 accelerated test types. This standard should be used in conjunction with statistical test plan  
199 standards such as IEC 61123, IEC 61124, IEC 61649 and IEC 61710.

200 The relative merits of various methods and their individual or combined applicability in  
201 evaluating a given system or item, should be reviewed by the product design team (including  
202 reliability engineering) prior to selection of a specific test method or a combination of methods.  
203 For each method, consideration should also be given to the test time, results produced,  
204 credibility of the results, data required to perform meaningful analysis, life cycle cost impact,  
205 complexity of analysis and other identified factors.

206 In this standard the term item is used as defined in IEC 60050-192 covering physical products  
207 as well as software. Services are however not covered by this standard.

208

209

## 210 METHODS FOR PRODUCT ACCELERATED TESTING

211  
212  
213

### 214 Scope

215 This International Standard provides guidance on the application of various accelerated test  
216 techniques for measurement or improvement of item reliability. Identification of potential failure  
217 modes that could be experienced in the use of an item and their mitigation is instrumental to  
218 ensure dependability of an item.

219 The object of the methods is to either identify potential design weakness or provide information  
220 on item reliability, or to achieve necessary reliability/availability improvement, all within a  
221 compressed or accelerated period of time. This standard addresses accelerated testing of non-  
222 repairable and repairable systems. It can be used for probability ratio sequential tests, fixed  
223 duration tests and reliability improvement/growth tests, where the measure of reliability may  
224 differ from the standard probability of failure occurrence.

225 This standard also extends to present accelerated testing or production screening methods that  
226 would identify weakness introduced into the item by manufacturing error, which could  
227 compromise item reliability.

### 228 Normative references

229 The following documents, in whole or in part, are normatively referenced in this document.

230 For dated references, only the edition cited applies. For undated references, the latest edition  
231 of the referenced document (including any amendments) applies.

232 IEC 60050-192:2015/AMD1:2016 Standard | Amendment 1 - International Electrotechnical  
233 Vocabulary (IEV) - Part 192: Dependability.

234

235 IEC 60068 (all parts), *Environmental testing*

236 IEC 60300-3-4, *Dependability management – Part 3: Application guide-Section 4: Guide to the*  
237 *specification of dependability requirements*

238 IEC 60300-3-5, *Dependability management – Part 3-5: Application guide – Reliability test*  
239 *conditions and statistical test principles*

240 IEC 60605-2, *Equipment reliability testing – Part 2: Design of test cycles*

241 *IEC 60605-4: 2001 Standard | Equipment reliability testing - Part 4: Statistical procedures for*  
242 *exponential distribution - Point estimates*

243

244 IEC 60605-6: 2007 *Equipment reliability testing - Part 6: Tests for the validity and estimation*  
245 *of the constant failure rate and constant failure intensity*

246 IEC 60721 (all parts), *Classification of environmental conditions*

247 IEC 60812, *Analysis techniques for system reliability – Procedure for failure mode and effects*  
248 *analysis (FMEA)*

249 IEC 61014:2003, *Programmes for reliability growth*

- 250 IEC 61123:2019 *Reliability testing - Compliance test plans for success ratio*
- 251 IEC 61124:2012, *Reliability testing – Compliance tests for constant failure rate and constant*  
252 *failure intensity*
- 253 IEC 61163-1, *Reliability stress screening – Part 1: Repairable assemblies manufactured in lots.*  
254
- 255 IEC 61163-2, *Reliability stress screening – Part 2: Electronic components*
- 256 IEC 61164:2004, *Reliability growth – Statistical test and estimation methods*
- 257 IEC 61649:2008, *Weibull analysis*
- 258 IEC 61709, *Electronic components – Reliability – Reference conditions for failure rates and*  
259 *stress models for conversion*
- 260 IEC 61710, *Power law model – Goodness-of-fit tests and estimation methods*
- 261 IEC 62740:2015 *Root cause analysis (RCA)*
- 262 IEC/TR 62380, *Reliability data handbook – Universal model for reliability prediction of*  
263 *electronics components, PCBs and equipment*
- 264 IEC 62429, *Reliability growth – Stress testing for early failures in unique complex systems*
- 265 **Terms, definitions, symbols and abbreviations**
- 266 For the purposes of this document, the term and definitions given in IEC 60050-192, as well as  
267 the following, apply.
- 268 NOTE Symbols for reliability, availability and maintainability measures follow those of  
269 IEC 60050-192:2015, where available.
- 270 **3.1 Terms and definitions**
- 271 **3.1.1**  
272 **activation energy**  
273  $E_a$   
274 empirical factor for estimating the acceleration caused by a change in absolute temperature
- 275 Note 1 to entry: Activation energy is usually measured in electron volts per degree Kelvin.
- 276 **3.1.2**  
277 **detection screen**  
278 low stress level exposure to detect intermittent faults
- 279 **3.1.3**  
280 **event compression**  
281 increasing stress repetition frequency to be considerably higher levels than it is in the field
- 282 **3.1.4**  
283 **highly accelerated limit test**  
284 HALT  
285 test or sequence of tests intended to identify the most likely failure modes of the product in a defined stress  
286 environment

- 287 Note 1 to entry: HALT is sometimes spelled out as the highly accelerated life test (as it was originally named in error).  
 288 However, as a non-measurable accelerated test, it does not provide information on life duration, but on the magnitude of  
 289 stress which represents the limit of the design.
- 290 **3.1.5**  
 291 **highly accelerated stress audit**  
 292 HASA  
 293 process monitoring tool where a sample from a production lot is tested to detect potential weaknesses in a  
 294 product caused by manufacturing
- 295 **3.1.6**  
 296 **highly accelerated stress screening**  
 297 HASS  
 298 screening intended to identify latent defects in a product caused by manufacturing process or control errors
- 299 **3.1.7**  
 300 **item**  
 301 subject being considered
- 302 Note 1 to entry: The item may be an individual part, component, device, functional unit, equipment, subsystem,  
 303 or system.
- 304 Note 2 to entry: The item may consist of hardware, software, people or any combination thereof.
- 305 Note 3 to entry: The item is often comprised of elements that may each be individually considered. See "sub-  
 306 item", definition 192-01-02 and "indenture level", definition 192-01-05.
- 307 Note 4 to entry: IEC 60050-191:1990 (now withdrawn; replaced by IEC 60050-192:2015) identified the term  
 308 "entity" as an English synonym, which is not true for all applications.
- 309 Note 5 to entry: The definition for item in IEC 60050-191:1990 (now withdrawn; replaced by IEC 60050-  
 310 192:2015) is a description rather than a definition. This new definition provides meaningful substitution throughout  
 311 this document. The words of the former definition form new note 1.
- 312 [SOURCE: IEC 60050-192:—, definition 192-01-01]
- 313 **3.1.9**  
 314 **life time**, <of a non-repairable item / component>  
 315 time interval from first use until user requirements are no longer met
- 316 NOTE 1 to entry: The end of life time is usually called failure of the component.  
 317  
 318 NOTE 2 to entry: The end of life is often defined as the time where a specified percentage of the components  
 319 have failed, for example stated as a B<sub>10</sub> or L<sub>10</sub> value for 10% accumulated failures.
- 320 **3.1.10**  
 321 **precipitation screen**  
 322 screening profile to precipitate, through failure, conversion of latent into revealed faults
- 323 **3.1.11**  
 324 **step stress test**  
 325 step stress test  
 326 test in which the applied stress is increased, after each specified interval, until failure occurs or a predetermined  
 327 stress level is reached
- 328 Note 1 to entry: The 'intervals' could be specified in terms of number of stress applications, durations, or test  
 329 sequences.
- 330 Note 2 to entry: The test should not alter the basic failure modes, failure mechanisms, or their relative  
 331 prevalence.
- 332 [SOURCE: IEC 60050-192:—, definition 192-09-10]

- 333 **3.1.12**  
 334 **test acceleration factor**  
 335 ratio of the stress response rate of the test specimen under the accelerated conditions, to the stress response rate  
 336 under specified operational conditions  
 337 Note 1 to entry: Both stress response rates refer to the same time interval in the life of the tested items.  
 338 Note 2 to entry: Measures of stress response rate are, for example, operating time to failure, failure intensity,  
 339 and rate of wear.

340 [SOURCE: IEC 60050-192:—, definition 192-09-09]  
 341

- 342 **3.1.13**  
 343 **time compression**  
 344 removal of exposure time at low or deemed non damaging stress levels from a test for purpose of acceleration

## 345 **3.2 Symbols and abbreviated terms**

346 <b>Symbol/ Abbreviation</b>	<b>Description</b>
348 ADT	accelerated degradation test(ing)
349 AF	acceleration, acceleration factor
350 $AF_{\text{test}}$	overall acceleration in a test
351 CALT	calibrated accelerated life testing
352 $B_{10}$	life time, the time where 10% of the items have failed
353 C	Confidence
354 CD	CD player in a HiFi equipment
355 DL	destruct limit
356 DSL	design specification limit
357 DVL	design verification level
358 FIT	failure in time (failure per. $10^9$ hours)
359 HALT	highly accelerated limit test
360 HASA	highly accelerated stress audit
361 HASS	highly accelerated stress screening test
362 HAST	highly accelerated stress test
363 L	Load
364 $L_v$	Lifetime ratio
365 LDL	lower destruct limit
366 LDT	lower destruct temperature
367 LOL	lower operating limit
368 LOT	lower operating temperature
369 LRTL	lower reliability test limit
370 MTBF	mean operating time between failures
371 MTTF	mean operating time to failure
372 OL	operating limit
373 OVL	operation vibration limit
374 PWB	Printed wiring board
375 $R(t)$	reliability as a function of time; probability of survival to the time $t$
376 RTL	reliability test level

377	S	Strength
378	SL	specification limit
379	SPRT	sequential probability ratio test
380	$t_0$	time denoted time 0
381	$t_L$	a specified time, e. g. life
382	THB	temperature humidity bias test
383	TTF	time to failure
384	UDL	upper destruct limit
385	UDT	upper destruct temperature
386	UOL	upper operating limit
387	UOT	upper operating temperature
388	URTL	upper reliability test limit
389	UUT	unit under test
390	VDL	Vibration Destruct Limit
391	$\lambda(S)$	failure rate as a function of a stress
392	$\lambda(t)$	failure rate as a function of time

393

## 394 **General description of the accelerated test methods**

### 395 **4.1 Cumulative damage model**

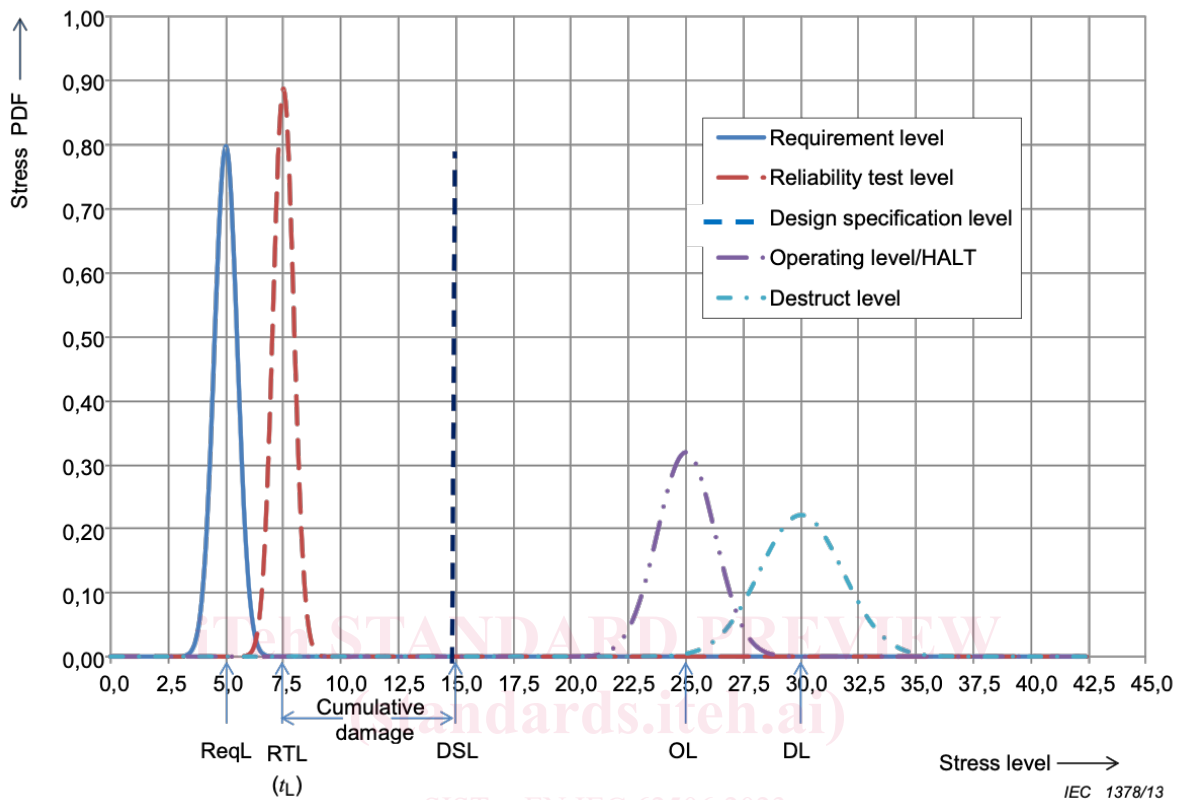
396 Accelerated testing of any type is based on the cumulative damage principle. The stresses of  
 397 the item in its life cause progressive damage that accumulates throughout the item life. This  
 398 damage may or may not result in a item's failure in the field.

399 The strategy of any type of accelerated testing is to produce, by increasing stress levels during  
 400 testing, cumulative damage equivalent to that expected in the item's life for the type of expected  
 401 stress. Determination of item destruct limits, without reliability estimation, provides information  
 402 on whether there exists a sufficient margin between those destruct limits and item specification  
 403 limits, thus providing assurance that the item will survive its predetermined life period without  
 404 failure related to that specific stress type. This technique may or may not necessarily quantify  
 405 a probability of item survival for its life, just assurance that the necessary adjustments in item  
 406 strength would help eliminate such failure in item use. Where sufficient margins are determined  
 407 unrelated to the probability of survival, the type of test is qualitative. In tests where this  
 408 probability of survival is determined, the magnitude of the stress is correlated to the probability  
 409 that the item would survive that stress type beyond the predetermined life, and this test type is  
 410 quantitative.

411 Figure 1 depicts the principle of cumulative damage in both qualitative and quantitative  
 412 accelerated tests.

413 In Figure 1, for simplicity, all stresses, operating limits, destruct limits, etc. are shown as  
 414 absolute values. The specification values for an item are usually given in both extremes, upper  
 415 and lower, thus the upper and lower (or low) specification limit, USL and LSL with the  
 416 corresponding design limits (DSL), UDL and LDL, the upper and lower operating limits, UOL  
 417 and LOL, and also the reliability test limits, URTL and LRTL. The rationale is that the opposite  
 418 (negative stresses), may also cause cumulative damage probably with a different failure  
 419 mechanism, thus the relationship between the expected and specified limits can be illustrated  
 420 in the same manner as for the high or positive stress. As an example, cold temperature  
 421 extremes might produce the same or different failure modes in a item. To avoid clutter, the

422 positive and the negative thermal or any other stresses are not separately shown in Figure 1,  
 423 thus the magnitudes of stresses are either positive or negative, and thus represented as  
 424 absolute values only as upper or lower limits.



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**Figure 1 – Probability density functions (PDF) for cumulative damage, degradation, and test types**

428 The graph in Figure 1 shows the required strength of a item regarding a stress for the duration  
 429 of its lifetime, from beginning of life (e.g. time when the item is made),  $t_0$  through the end of  
 430 life,  $t_L$ . The strength and stresses in tests are also assumed to have a Gaussian distribution.

431 The different types of accelerated tests can now be illustrated using Figure 1 as a conceptual  
 432 model.

433 Functional testing is carried out within the range of the requirement specification and at the  
 434 level of the specification. In this area no failures should occur during the test; design is validated  
 435 to allow operation within the upper and lower specification limits. Accelerated testing of Type B  
 436 and C (4.2.3 and 4.2.4), i.e. accelerated degradation testing (ADT) or cumulative damage  
 437 testing can be illustrated as the distance between the design specification level (DSL) and the  
 438 level where the reliability demonstration test should be performed (RTL). When the degradation  
 439 reduces the performance below the requirement specifications the item can be declared as  
 440 failed, if this behaviour is defined as a failure. When testing the item at time  $t_0$  no failures should  
 441 be expected for stress levels up to and including the design specification level (DSL).

442 The item design specification should take into consideration certain degradation during the  
 443 item's life which is resultant from the cumulative damage of the stresses expected in life, thus  
 444 its limit is the design specification limit (DSL) which is higher than the requirement limit (RL) in  
 445 order to provide the necessary margin. After item degradation resultant from the cumulative  
 446 damage caused by expected stresses, the reliability test provides information on the existing  
 447 margin between the test level (the remaining strength) and the requirement. This margin is a  
 448 measure of reliability at the end of required period,  $t_L$ .